AUTOMOTIVE GRADE

RoHS

COMPLIANT

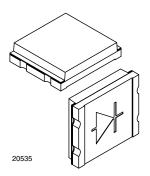
GREEN

(5-2008)**



Vishay Semiconductors

Silicon PIN Photodiode



DESCRIPTION

TEMD5080X01 is a PIN photodiode with enhanced blue sensitivity. The miniature surface mount package (SMD) include a chip with 7.7 mm² sensitive area, covered by clear epoxy.

FEATURES

- Package type: surface mount
- · Package form: top view
- Dimensions (L x W x H in mm): 5 x 4.24 x 1.12
- Radiant sensitive area (in mm2): 7.7
- AEC-Q101 qualified
- Enhanced blue photo sensitivity: S (400 nm) rel > 30 %
- Peak sensitivity at 940 nm
- Suitable for visible and near infrared radiation
- · Low junction capacitance
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 65^{\circ}$
- Floor life: 72 h, MSL 4, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

• High speed photo detector

PRODUCT SUMMARY				
COMPONENT	I _{ra} (μA)	φ (deg)	λ0.1 (nm)	
TEMD5080X01	60	± 65	350 to 1100	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TEMD5080X01	Tape and reel	MOQ: 1500 pcs, 1500 pcs/reel	Top view	

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	25	V
Power dissipation	T _{amb} ≤ 25 °C	P _V	215	mW
Junction temperature		Tj	100	°C
Operating temperature range		T _{amb}	- 40 to + 100	°C
Storage temperature range		T _{stg}	- 40 to + 110	°C
Soldering temperature	Acc. reflow solder profile fig. 8	T _{sd}	260	°C
Thermal resistance junction/ambient		R _{thJA}	350	K/W

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PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F		1	1.3	V
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	25			V
Reverse dark current	V _R = 10 V, E = 0	I _{ro}		2	10	nA
Diode capacitance	V _R = 0 V, f = 1 MHz, E = 0	C _D		90		pF
	V _R = 3 V, f = 1 MHz, E = 0	C _D		30	40	pF
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	Vo		350		mV
Temperature coefficient of Vo	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	TK _{Vo}		- 2.6		mV/K
Short circuit current	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	I _k		50		μA
Temperature coefficient of I _k	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	TK _{Ik}		0.1		%/K
Reverse light current	$E_{e}=1~\text{mW/cm}^{2},\lambda=400~\text{nm},\\ V_{R}=5~\text{V}$	I _{ra}		18		μΑ
	$E_V = 100 \text{ Ix, CIE illuminant A,}$ $V_R = 5 \text{ V}$	I _{ra}		8.5		μΑ
	E_e = 1 mW/cm ² , λ = 950 nm, V_R = 5 V	I _{ra}		60		μΑ
Temperature coefficient of I _{ra}	CIE illuminant A	TK _{lra}		0.15		%/K
	$\lambda = 950 \text{ nm}$	TK _{lra}		0.1		%/K
Angle of half sensitivity		φ		± 65		deg
Wavelength of peak sensitivity		λ_{p}		940		nm
Range of spectral bandwidth		λ _{0.1}		350 to 1100		nm
Noise equivalent power	V _R = 10 V, λ = 400 nm	NEP		1.1 x 10 ⁻¹³		W/√Hz
Rise time	$V_R = 5 \text{ V}, R_L = 50 \Omega,$ $\lambda = 850 \text{ nm}$	t _r		40		ns
Fall time	$V_R = 5 \text{ V}, R_L = 50 \Omega,$ $\lambda = 850 \text{ nm}$	t _f		40		ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

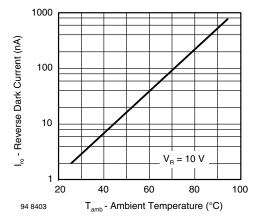


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

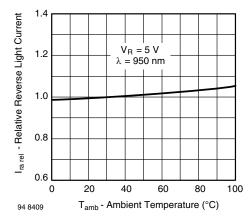


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

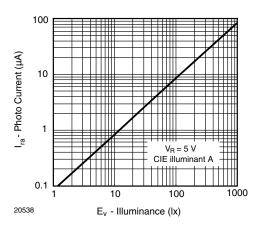


Fig. 3 - Reverse Light Current vs. Irradiance

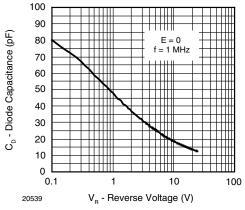


Fig. 4 - Diode Capacitance vs. Reverse Voltage

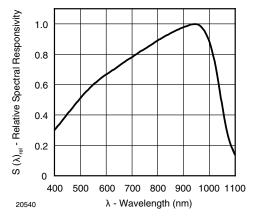


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

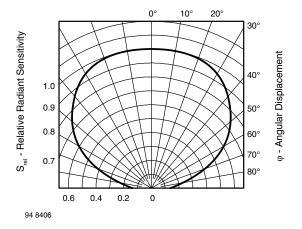
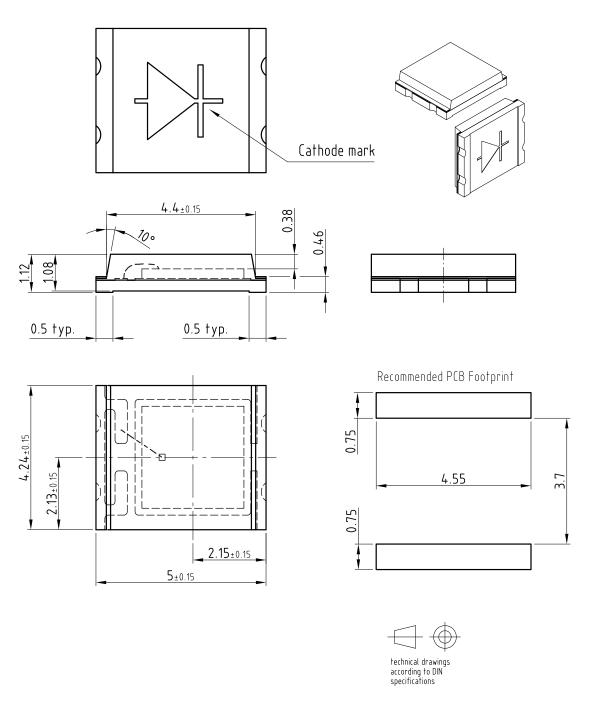


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters



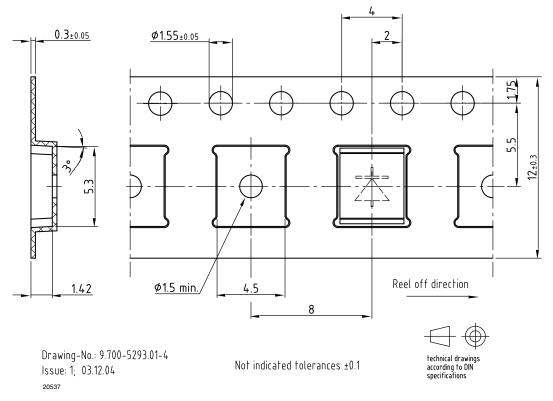
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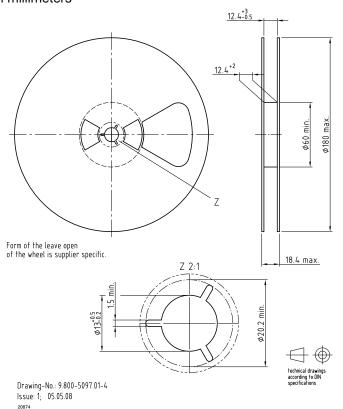
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Not indicated tolerances ± 0.1

TAPING DIMENSIONS in millimeters



REEL DIMENSIONS in millimeters



SOLDER PROFILE

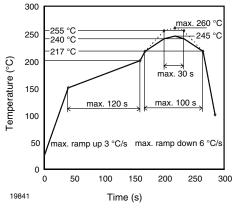


Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions: T_{amb} < 30 °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 %

or

96 h at 60 °C (+ 5 °C), RH < 5 %.

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Vishay

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